DAP	06/21/2012 R116239US01
6-18-12	Patent and Trademark Office
	riease record une attached to the new address(es) below.
1. Name of conveying party(ies):	2. Name and address of receiving party(ies):
Takashi TOKAIRIN	Name D. Company
	Name: Renesas Electronics Corporation
•	Address: 1753, Shimonumabe, Nakahara-ku
↑ ( 'Barrel a constant of a c	
Additional names(s) of conveying party(ies)  1. Nature of conveyance/Execution Date(s):	+
Execution Date(s): May 30, 2012	
✓ Assignment	City: Kawasaki-shi
☐ Security Agreement ☐ Change of Name	State/Prov.: Kanagawa
☐ Joint Research Agreement	
☐ Government Interest Assignment	Country: Japan ZIP:
Executive Order 9424, Confirmatory License	
Other	Additional name(s) & address(es) attached? ☐ Yes ☒ No
4. Application or patent numbers(s):	
A. Patent Application No. (s)	☐ This document is being filed together with a new application. ☐ B. Patent No.(s)
: A. Fatent Application No. (3)	B. Patent No.(s)
13/525,099	
13/32/07/	
Additional numbers atta	ched? Tyes XI No
5. Name and address to whom correspondence	
concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Sean M. McGinn, Esq.	
Registration No.: 34, 386	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00
Address: McGinn Intellectual Property Law Group, PLLC	
8321 Old Courthouse Road	☐ Authorized to be charged by credit card
	☐ Authorized to be charged to deposit account
Suite 200	⊠ Enclosed
City: Vienna	☐ None required (government interest not affecting title)
State/Prov.: Virginia	8. Payment Information
Country: <u>USA</u> ZIP: <u>22182-3817</u>	a. Credit Card Last 4 Numbers
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Fax Number: (703) 761-2375 or 76	b. Deposit Account Number 50-0481 (deficiencies only)
Email Address: admin@mcginniplaw.com	
	Authorized User Name Sean M. McGinn
9. Signature:	AP\51\5015 WANTTIUP ADARANA 132520AA
CXVIMUSTS	June 18, 2012 P
Signature	Date
Sean M. McGinn, Esq.	Total number of pages including cover

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## ASSIGNMENT (譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Electronics Corporation, a corporation organized under the laws of Japan,

located at 1753, Shimonumabe, Nakahara-ku, Kawasaki-shi, Kanagawa, Japan,

receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Electronics Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

## OSCILLATION CIRCUIT AND SEMICONDUCTOR INTEGRATED CIRCUIT INCLUDING THE SAME

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Renesas Electronics Corporation,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Electronics Corporation,

Signed on the date(s) indicated aside our signatures:

-	INVENTOR(S)	
•	(発明者フルネームサイ	ン)

**Date Signed** (署名日)

1) Jakashi Jologism Takashi TOKAIRIN	Mar 30, 20/2
2)	
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9)	
10)	

**PATENT REEL: 028450 FRAME: 0567** 

RECORDED: 06/18/2012